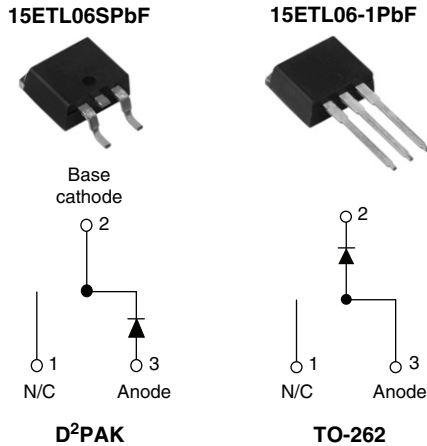


Ultralow V_F Hyperfast Rectifier for Discontinuous Mode PFC, 15 A FRED Pt™



FEATURES

- Benchmark ultralow forward voltage drop
- Hyperfast recovery time
- Low leakage current
- 175 °C operating junction temperature
- Lead (Pb)-free ("PbF" suffix)
- Designed and qualified for Q101 level



RoHS*
COMPLIANT

DESCRIPTION

State of the art, ultralow V_F , soft-switching hyperfast rectifiers optimized for Discontinuous (Critical) Mode (DCM) Power Factor Correction (PFC).

The minimized conduction loss, optimized stored charge and low recovery current minimize the switching losses and reduce over dissipation in the switching element and snubbers.

The device is also intended for use as a freewheeling diode in power supplies and other power switching applications.

APPLICATIONS

AC-DC SMPS 70 W to 400 W

e.g. laptop and printer AC adaptors, desktop PC, TV and monitor, games units and DVD AC-DC power supplies.

PRODUCT SUMMARY

V_F (typical)	0.99 V
$I_{F(AV)}$	15 A
V_R	600 V

ABSOLUTE MAXIMUM RATINGS

PARAMETER	SYMBOL	TEST CONDITIONS	MAX.	UNITS
Peak repetitive reverse voltage	V_{RRM}		600	V
Average rectified forward current	$I_{F(AV)}$	$T_C = 154\text{ °C}$	15	A
Non-repetitive peak surge current	I_{FSM}	$T_J = 25\text{ °C}$	250	
Peak repetitive forward current	I_{FM}		30	
Operating junction and storage temperatures	T_J, T_{Stg}		- 65 to 175	°C

ELECTRICAL SPECIFICATIONS ($T_J = 25\text{ °C}$ unless otherwise specified)

PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS
Breakdown voltage, blocking voltage	V_{BR}, V_R	$I_R = 100\text{ }\mu\text{A}$	600	-	-	V
Forward voltage	V_F	$I_F = 15\text{ A}$	-	0.99	1.05	V
		$I_F = 15\text{ A}, T_J = 150\text{ °C}$	-	0.85	0.92	
Reverse leakage current	I_R	$V_R = V_R$ rated	-	0.1	10	μA
		$T_J = 150\text{ °C}, V_R = V_R$ rated	-	15	120	
Junction capacitance	C_T	$V_R = 600\text{ V}$	-	20	-	pF
Series inductance	L_S	Measured lead to lead 5 mm from package body	-	8.0	-	nH

* Pb containing terminations are not RoHS compliant, exemptions may apply

15ETL06SPbF/15ETL06-1PbF



Vishay High Power Products

Ultralow V_F Hyperfast Rectifier for
Discontinuous Mode PFC, 15 A FRED Pt™

DYNAMIC RECOVERY CHARACTERISTICS ($T_C = 25\text{ }^\circ\text{C}$ unless otherwise specified)						
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS
Reverse recovery time	t_{rr}	$I_F = 1\text{ A}$, $di_F/dt = 100\text{ A}/\mu\text{s}$, $V_R = 30\text{ V}$	-	60	120	ns
		$I_F = 15\text{ A}$, $di_F/dt = 100\text{ A}/\mu\text{s}$, $V_R = 30\text{ V}$	-	190	270	
		$T_J = 25\text{ }^\circ\text{C}$	-	220	-	
		$T_J = 125\text{ }^\circ\text{C}$	-	320	-	
Peak recovery current	I_{RRM}	$T_J = 25\text{ }^\circ\text{C}$	-	19	-	A
		$T_J = 125\text{ }^\circ\text{C}$	-	26	-	
Reverse recovery charge	Q_{rr}	$T_J = 25\text{ }^\circ\text{C}$	-	2.2	-	μC
		$T_J = 125\text{ }^\circ\text{C}$	-	4.3	-	

THERMAL - MECHANICAL SPECIFICATIONS						
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS
Maximum junction and storage temperature range	T_J , T_{Stg}		- 65	-	175	$^\circ\text{C}$
Thermal resistance, junction to case per leg	R_{thJC}		-	1.0	1.3	$^\circ\text{C}/\text{W}$
Thermal resistance, junction to ambient per leg	$R_{thJA}^{(1)}$	Typical socket mount	-	-	70	
Thermal resistance, case to heatsink	$R_{thCS}^{(2)}$	Mounting surface, flat, smooth and greased	-	0.5	-	
Weight			-	2.0	-	g
			-	0.07	-	oz.
Mounting torque			6.0 (5.0)	-	12 (10)	kgf · cm (lbf · in)
Marking device		Case style D ² PAK	15ETL06S			
		Case style TO-262	15ETL06-1			

15ETL06SPbF/15ETL06-1PbF

Vishay High Power Products

Ultralow V_F Hyperfast Rectifier for
Discontinuous Mode PFC, 15 A FRED Pt™



ORDERING INFORMATION TABLE

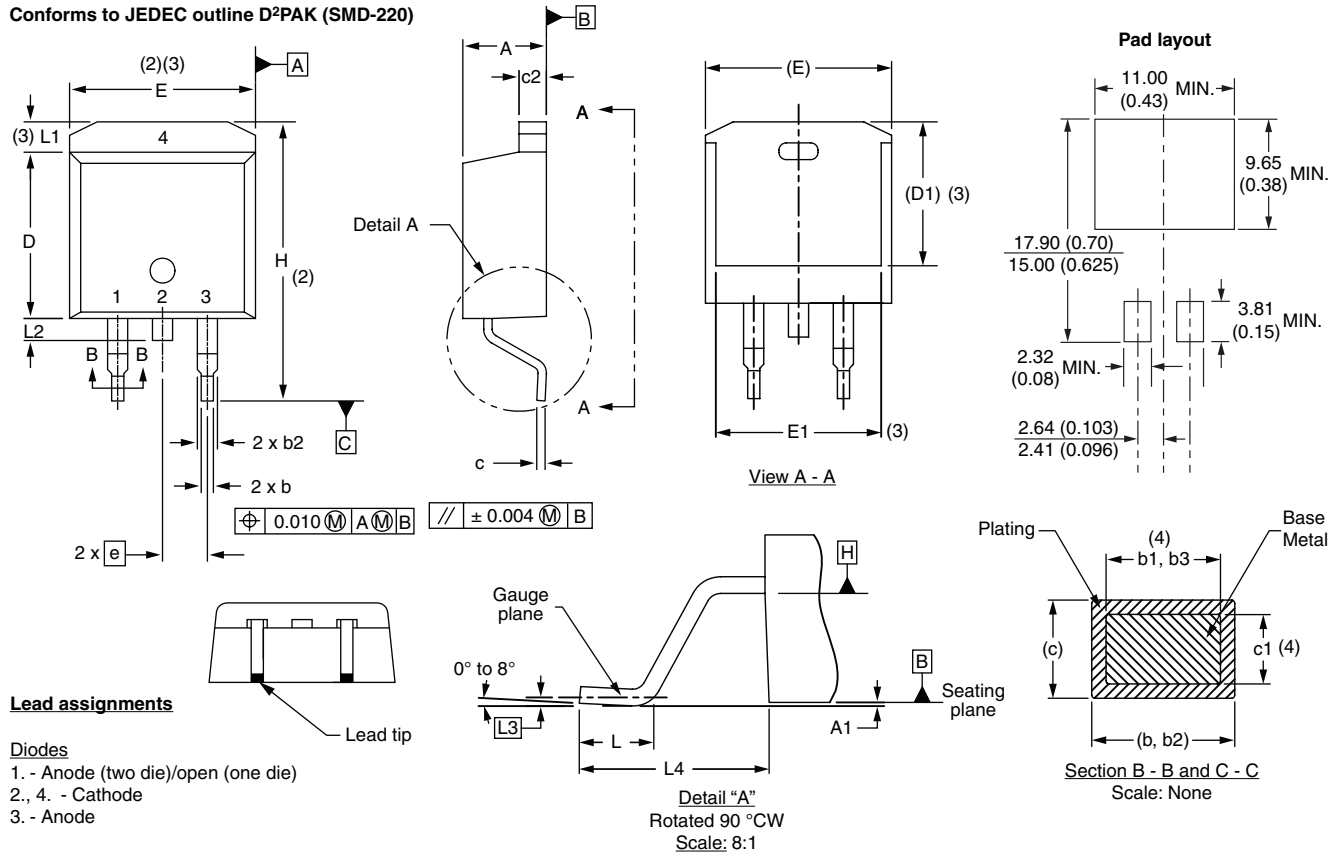
Device code	15	E	T	L	06	S	TRL	PbF
	①	②	③	④	⑤	⑥	⑦	⑧

- 1** - Current rating (15 A)
- 2** - E = Single diode
- 3** - T = TO-220, D²PAK
- 4** - L = Ultralow V_F hyperfast recovery
- 5** - Voltage rating (06 = 600 V)
- 6** -
 - S = D²PAK
 - -1 = TO-262
- 7** -
 - None = Tube (50 pieces)
 - TRL = Tape and reel (left oriented, for D²PAK package)
 - TRR = Tape and reel (right oriented, for D²PAK package)
- 8** -
 - None = Standard production
 - PbF = Lead (Pb)-free

D²PAK, TO-262

DIMENSIONS FOR D²PAK in millimeters and inches

Conforms to JEDEC outline D²PAK (SMD-220)



SYMBOL	MILLIMETERS		INCHES		NOTES
	MIN.	MAX.	MIN.	MAX.	
A	4.06	4.83	0.160	0.190	
A1	0.00	0.254	0.000	0.010	
b	0.51	0.99	0.020	0.039	
b1	0.51	0.89	0.020	0.035	4
b2	1.14	1.78	0.045	0.070	
b3	1.14	1.73	0.045	0.068	4
c	0.38	0.74	0.015	0.029	
c1	0.38	0.58	0.015	0.023	4
c2	1.14	1.65	0.045	0.065	
D	8.51	9.65	0.335	0.380	2

SYMBOL	MILLIMETERS		INCHES		NOTES
	MIN.	MAX.	MIN.	MAX.	
D1	6.86	-	0.270	-	3
E	9.65	10.67	0.380	0.420	2, 3
E1	6.22	-	0.245	-	3
e	2.54 BSC		0.100 BSC		
H	14.61	15.88	0.575	0.625	
L	1.78	2.79	0.070	0.110	
L1	-	1.65	-	0.066	3
L2	1.27	1.78	0.050	0.070	
L3	0.25 BSC		0.010 BSC		
L4	4.78	5.28	0.188	0.208	

Notes

- (1) Dimensioning and tolerancing per ASME Y14.5 M-1994
- (2) Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outmost extremes of the plastic body
- (3) Thermal pad contour optional within dimension E, L1, D1 and E1
- (4) Dimension b1 and c1 apply to base metal only
- (5) Datum A and B to be determined at datum plane H
- (6) Controlling dimension: inch
- (7) Outline conforms to JEDEC outline TO-263AB

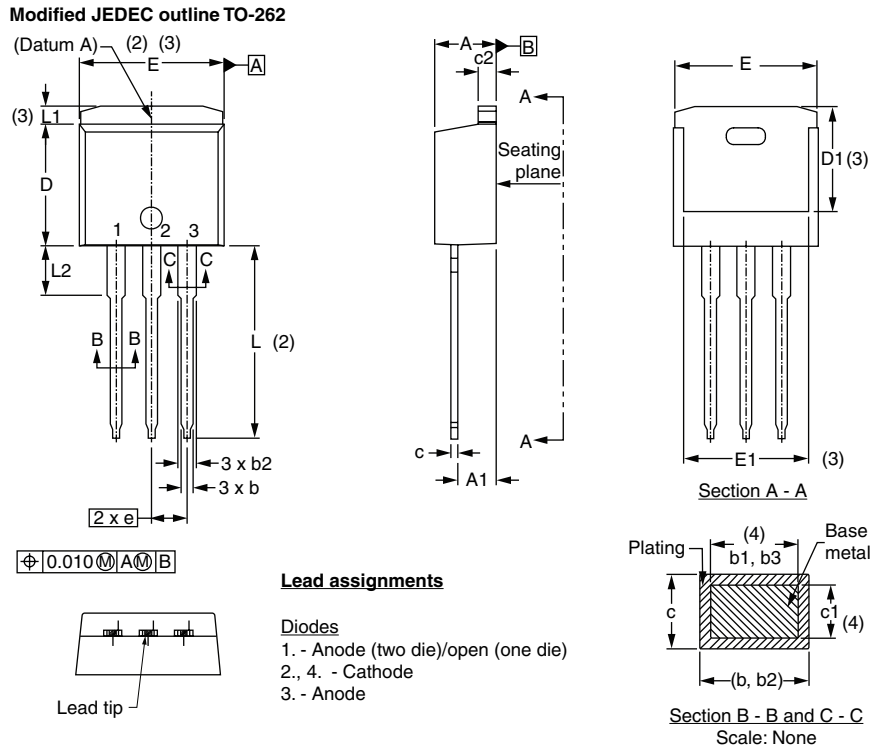
Outline Dimensions

Vishay High Power Products

D²PAK, TO-262



DIMENSIONS FOR TO-262 in millimeters and inches



SYMBOL	MILLIMETERS		INCHES		NOTES
	MIN.	MAX.	MIN.	MAX.	
A	4.06	4.83	0.160	0.190	
A1	2.03	3.02	0.080	0.119	
b	0.51	0.99	0.020	0.039	
b1	0.51	0.89	0.020	0.035	4
b2	1.14	1.78	0.045	0.070	
b3	1.14	1.73	0.045	0.068	4
c	0.38	0.74	0.015	0.029	
c1	0.38	0.58	0.015	0.023	4
c2	1.14	1.65	0.045	0.065	
D	8.51	9.65	0.335	0.380	2
D1	6.86	-	0.270	-	3
E	9.65	10.67	0.380	0.420	2, 3
E1	6.22	-	0.245	-	3
e	2.54 BSC		0.100 BSC		
L	13.46	14.10	0.530	0.555	
L1	-	1.65	-	0.065	3
L2	3.56	3.71	0.140	0.146	

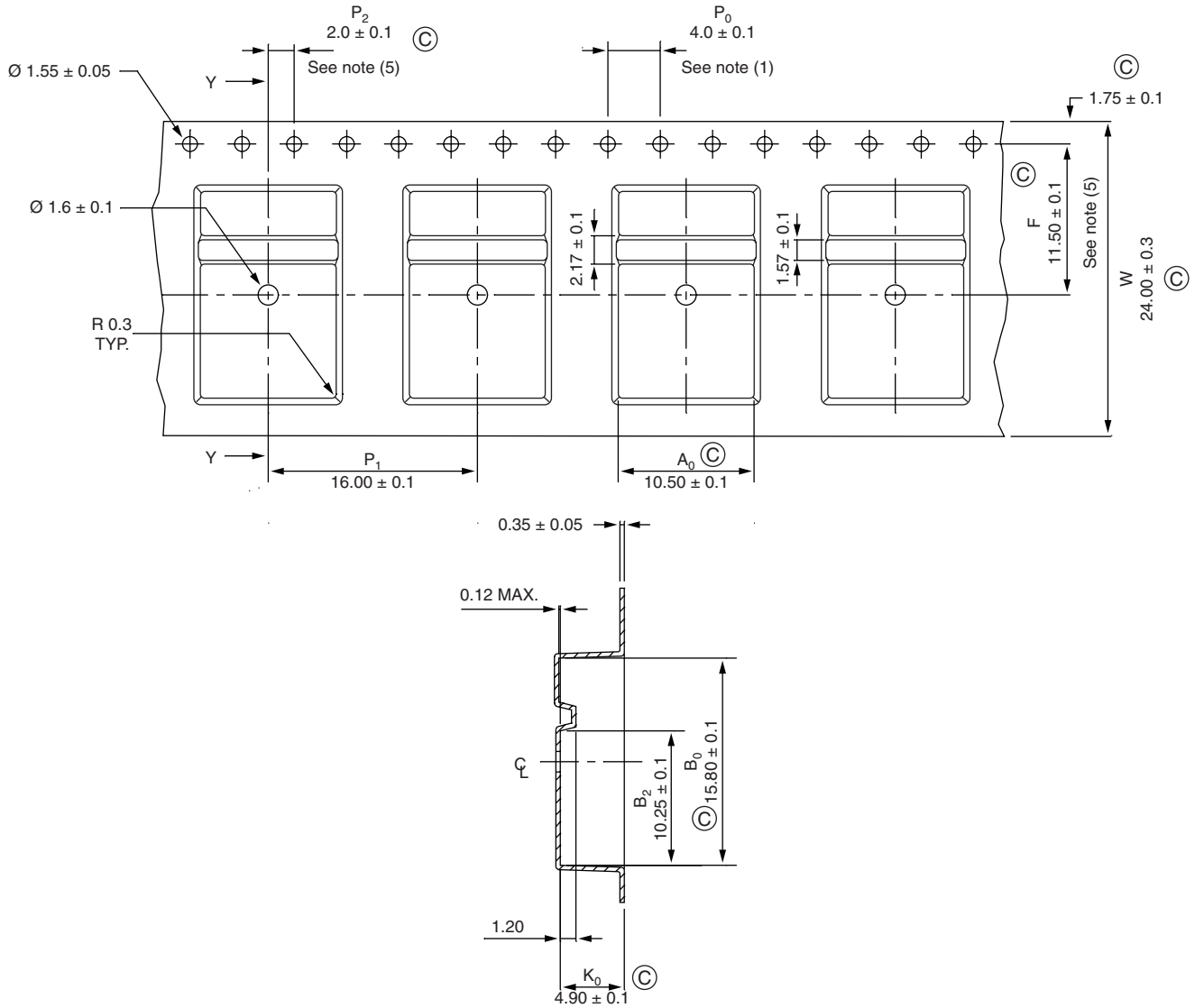
Notes

- (1) Dimensioning and tolerancing as per ASME Y14.5M-1994
- (2) Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outmost extremes of the plastic body
- (3) Thermal pad contour optional within dimension E, L1, D1 and E1
- (4) Dimension b1 and c1 apply to base metal only
- (5) Controlling dimension: inches

- (6) Outline conform to JEDEC TO-262 except A1 (maximum), b (minimum) and D1 (minimum) where dimensions derived the actual package outline

D²PAK

TAPE AND REEL INFORMATION in millimeters (inches)



Section Y - Y

Notes

- (1) 10 sprocket hole pitch cumulative tolerance ± 0.02
- (2) Camber not to exceed 1 mm in 100 mm
- (3) Material: conductive black styrenic alloy
- (4) K_0 measured from a plane on the inside bottom of the pocket to the top surface of the carrier
- (5) Measured from centerline of sprocket hole to centerline of pocket
- (6) Vendor: (optional)
- (7) Must also meet requirements of EIA standard # EIA-481A taping of surface mount components for automatic placement
- (8) Surface resistivity of molded material must measure less or equal to $10^6 \Omega$ per square. Measured in accordance to procedure given in ASTM D-257 and ASTM D-991
- (9) Total length per reel must be 45 m
- (10) Ⓢ critical